



SPECIFICATION

• Supplier : Samsung electro-mechanics • Samsung P/N : CL10A225KA8NNNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 2.2 µF, 25V, ±10%, X5R, 1608

A. Samsung Part Numbe

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1	Series	Samsung Multi-layer Ceramic Capacitor						
2	Size	0603 (inch code)	L: 1.6	± 0.1 mm V	N:	8.0	± 0.1	mm
3	Dielectric	X5R	8	Inner electrode		Ni		
4	Capacitance	2.2 μF		Termination		Cu		
(5)	Capacitance	±10 %		Plating		Sn 10	0%	(Pb Free)
	tolerance		9	Product		Norma	al	
6	Rated Voltage	25 V	10	Special		Reser	ved for	future use
7	Thickness	0.8 ± 0.1 mm	11)	Packaging		Cardb	oard Ty	ype, 7" reel

B. Samsung Reliablility Test and Judgement condition

	Performance	condition					
Capacitance	Within specified tolerance	1㎞±10% 1.0±0.2Vrms					
Tan δ (DF)	0.1 max.						
Insulation	10,000Mohm or 100Mohm⋅µF	Rated Voltage 60~120 sec.					
Resistance	Whichever is Smaller						
Appearance	No abnormal exterior appearance	Microscope (×10)					
Withstanding	No dielectric breakdown or	250% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	X5R						
Characterisitcs	(From -55 ℃ to 85 ℃, Capacitance change shoud be within ±15%)						
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)					
		with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	1) Sn63Pb37 solder					
	is to be soldered newly	235±5℃, 5±0.5sec.					
		2) SnAg3.0Cu0.5 solder					
		245±5°C, 3±0.3sec.					
		(preheating : 80~120℃ for 10~30sec.)					
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.					
Soldering heat	Tan δ, IR : initial spec.						

	Performance	condition				
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm				
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)				
		2hours × 3 direction (x, y, z)				
Humidity	Capacitance change : within ±12.5%	40±2℃, 90~95%RH, 500+12/-0hrs				
	Tan 0.2 max					
	IR: 25MΩ·μF or Over					
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage				
Resistance	Tan 0.2 max	Max. operating temperature				
	IR: 25№ μF or Over					
		1000+48/-0hrs				
Temperature	Capacitance change : within ±7.5%	1 cycle condition				
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25°C				
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}$ C				
		5 cycle test				

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C , 10sec. Max)

^{*} For the more detail Specification, Please refer to the Samsung MLCC catalogue.